

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	931	(wafer semiconductor microelectronic microfeature) with (electroplat\$ electrodeposit\$) same (uniform\$3 non\$1uniform\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/17 10:26
L3	516	(wafer semiconductor microelectronic microfeature) with (electroplat\$ electrodeposit\$) with (uniform\$3 non\$1uniform\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/17 10:26
L4	90	(wafer semiconductor microelectronic microfeature) with (electroplat\$ electrodeposit\$) with (non\$1uniform\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/17 10:54
L5	16	(wafer semiconductor microelectronic microfeature).clm. and (electroplat\$ electrodeposit\$).clm. and (non\$1uniform\$3).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/17 10:56
L6	10	(wafer semiconductor microelectronic microfeature).clm. and (electroplat\$ electrodeposit\$).clm. and (non\$1uniform\$3).clm.	US-PGPUB	OR	ON	2006/05/17 11:10
L7	1	"7020537".pn.	USPAT	OR	ON	2006/05/17 11:10